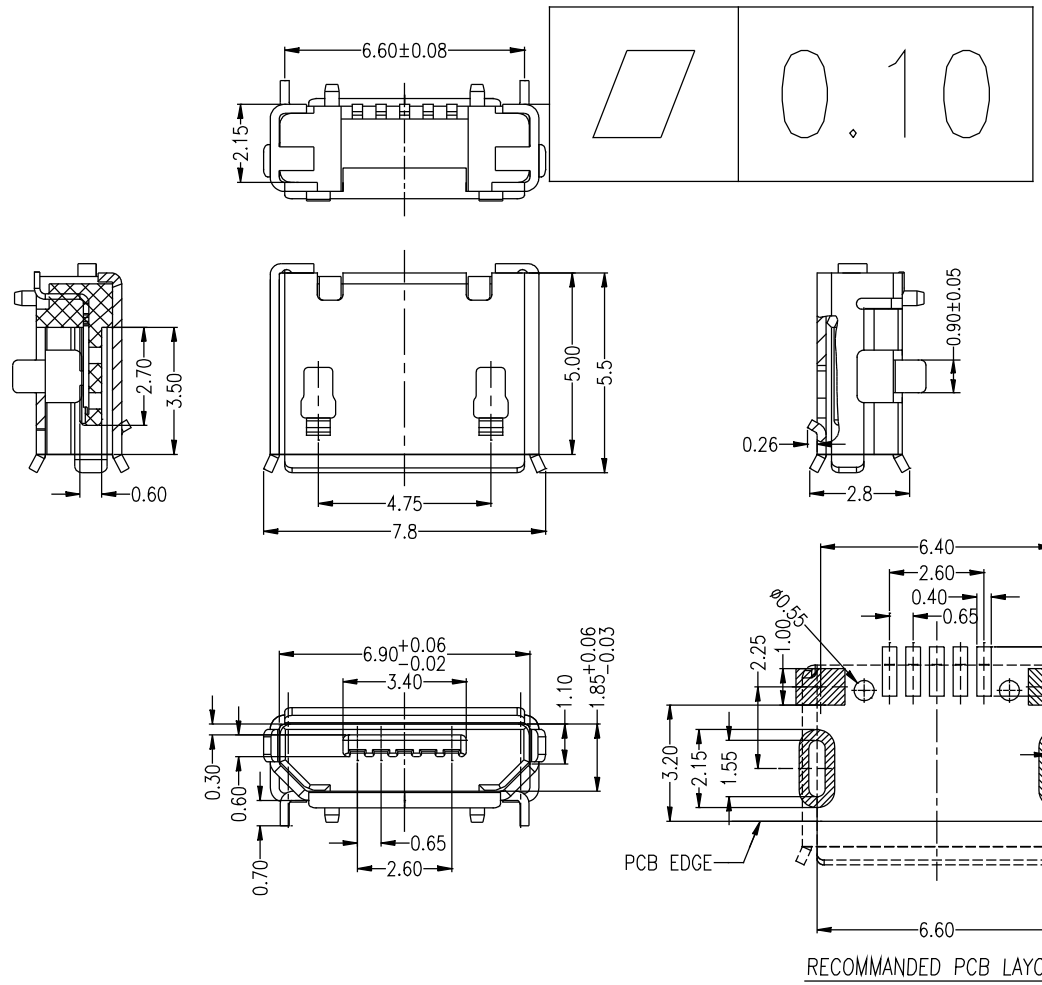
序号 MARK	设变内容 MODIFICATION	日期 DATE	修改 DRAW	核准 APPROVE



Note:
1.Material:
- 1.1 Housing: High temperature thermoplastic with g.f,UL94v-0
- 1.2 Contact: copper alloy,t=0.15mm
- 1.3 Shell: copper alloy,t=0.25mm

2.Specification:
- 2.1 Current rating: 1 A Max.
- 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
- 2.3 Contact resistance: 50 mW Max.
- 2.4 Insulation resistance: 100 MW Min.
- 2.5 Total mating force: 3.57 Kgf Max.
- 2.6 Total unmating force: 1.0 Kgf Min.0.81~2.05 Kgf Min.after 10000 insertion/extration cycles
- 2.7 Temperature range: -30°C~80°C

深圳市微连电子有限公司

Shenzhen Welink Electronics Co.,Ltd

一般公差	
XX. ±	XXX. ±
.X ± 0.25	.XXX ±
.XX ± 0.15	X.° ± 3°
.XXX ± 0.05	.X° ± 0.5°

比例 SCALE	N/A	绘图 DRAWIN	W-J-C	日期 DATE	2013.08.01
单位 UNIT	MM	审核 CHECKED		日期 DATE	
尺寸 SIZE	A4	核准 APPROVE		日期 DATE	

图号 DRW NO:	WL-USB021-001	版次 REV.	1.0
名称 TITLE	Micro usb 5s 6.6有焊脚有柱	頁次 PAGE	1/1